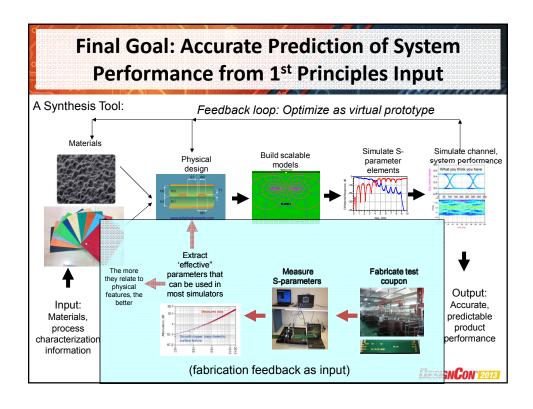
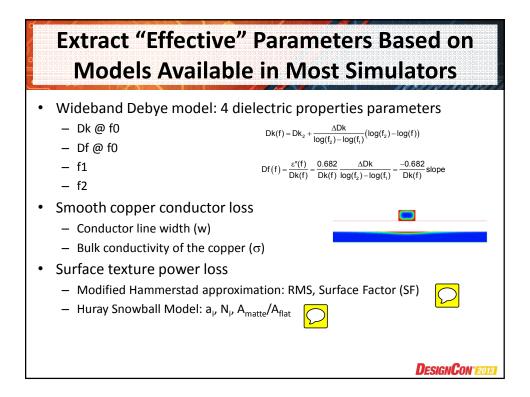
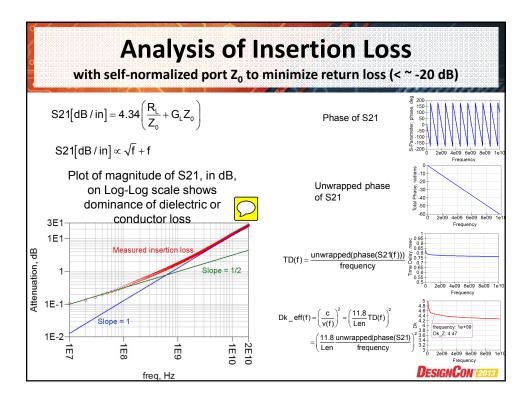


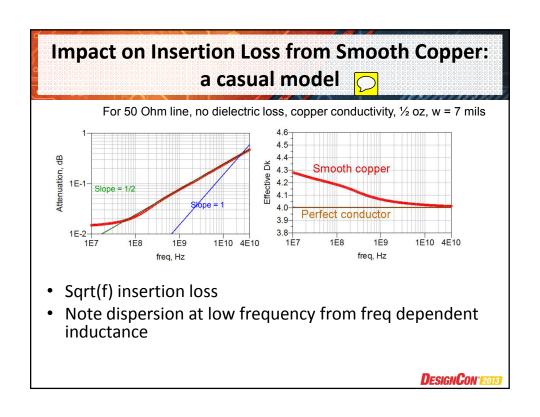
Overview

- Eric:
 - Introduction: the challenge
 - A practical process
 - Causal smooth copper and dielectric loss models
- Paul:
 - Copper surface texture first principles model and measurements
- Yuriy:
 - Copper surface texture approximations and measurements
- Don:
 - Summary: so what? closing the design manufacturing design feedback loop





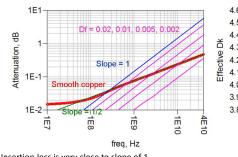


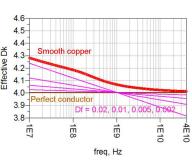


Wide Band Debye Dielectric Loss

$$Df\big(f\big) = \frac{\epsilon''(f)}{Dk(f)} = \frac{0.682}{Dk(f)} \frac{\Delta Dk}{log(f_2) - log(f_1)} = \frac{-0.682}{Dk(f)} slope$$

$$Dk(f) = Dk_2 + \frac{\Delta Dk}{log(f_2) - log(f_1)} \left(log(f_2) - log(f)\right)$$





- Insertion loss is very close to slope of 1
- Df relates to value of insertion loss and slope of Dk with frequency
- Lower loss \rightarrow less dielectric dispersion
- At low loss, conductor loss and dispersion may dominate

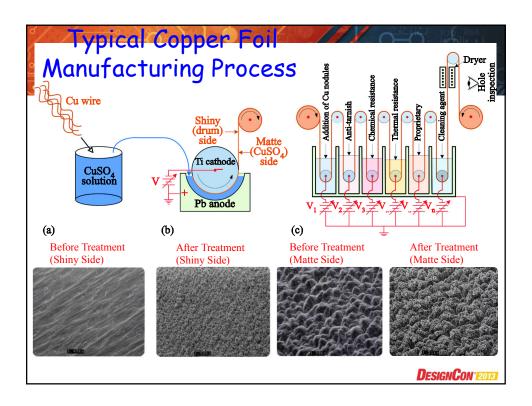


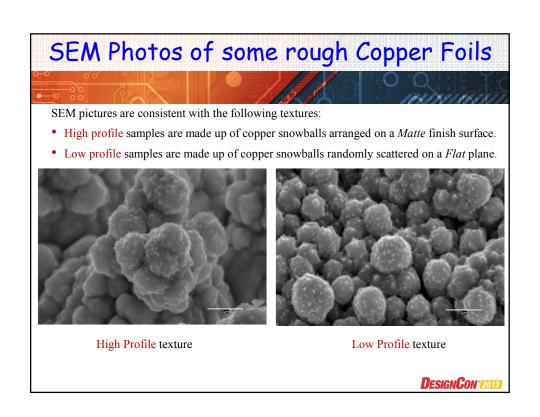


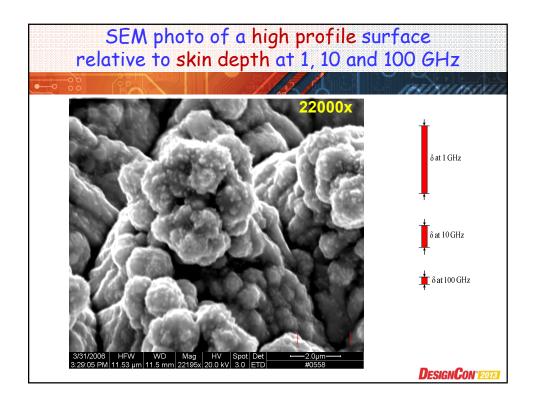
Professor Paul Huray

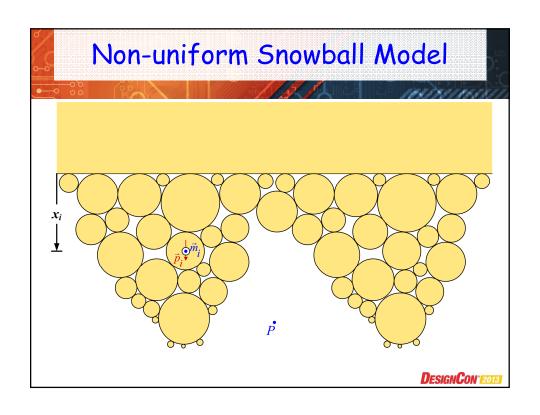
University of S. Carolina

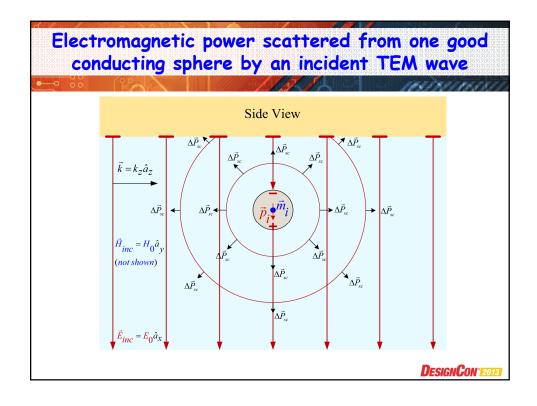


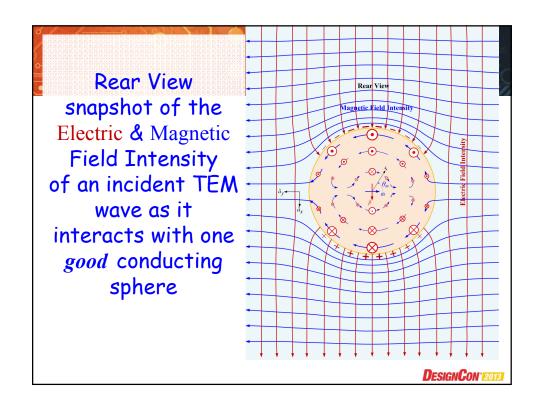












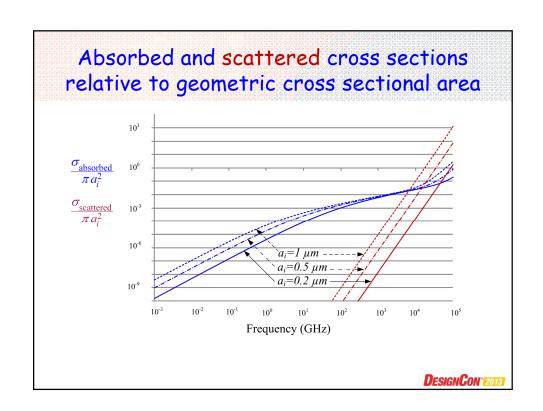
Good Conductor Cross Sections

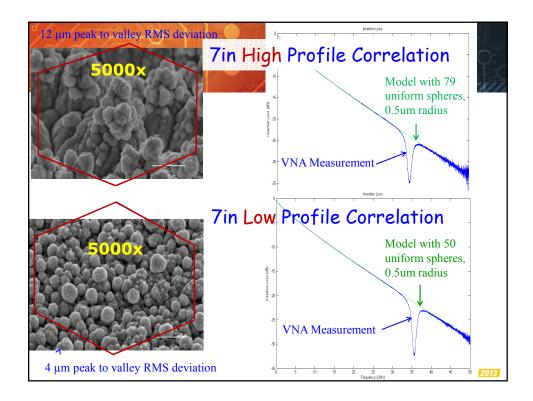
• For a good conducting sphere the respective cross-sections, σ , consistent with conductor surface impedance (neglecting quadrupole and higher multipole terms) are:

$$\sigma_{absorbed}(\omega) \approx 3\pi k_2 a_i^2 \delta / \left[1 + \frac{\delta}{a_i} + \frac{\delta^2}{2a_i^2} \right]$$

$$\sigma_{scattered}(\omega) \approx \frac{10\pi}{3} k_2^4 a_i^6 \left[1 + \frac{2}{5} \left(\frac{\delta}{a_i} \right) \right]$$

- $k_2 = \omega/c_2 = \sqrt{\varepsilon_{r,2}} \omega/c$ is the wave number in the propagating medium so the scattered power is in the form of Rayleigh scattering $(\omega^4 a_i^6)$ which is large at optical frequencies.
- For a 1 μm radius sphere and frequencies below 9 THz, the absorption cross section is larger than the scattering cross section so that below 100 GHz power lost to scattering may be neglected.
- At 100 GHz, the skin depth, δ , is small compared to radius, $a_i = 0.5 \lim_{n \to \infty} 8\pi k_0 n^2 \delta$ spheres of that radius absorb incident power with cross-section





Takeaways for Surface Roughness loss

 The relative power loss produced by a copper surface (as a function of frequency) for a PCB that is roughened by electrodepositing anchor nodules on a *Matte* surface is larger than the power loss of a *Flat* surface by:

$$\frac{P_{rough}}{P_{smooth}} \approx \frac{A_{Matte}}{A_{Flat}} + \frac{3}{2} \sum_{i=1}^{j} \left(\frac{N_i 4\pi a_i^2}{A_{Flat}} \right) / \left[1 + \frac{\delta}{a_i} + \frac{\delta^2}{2a_i^2} \right]$$
 Huray Model

Conclusions:

- The relative power loss for a stack-up of anchor nodules on a *Matte* surface is independent of the RMS deviation, △.
- The relative power loss depends only on:
 - A_{Matte} / A_{Flat}
 - The number, N_i , per unit area, A_{Flat} , of the various additional anchor nodules of radius, a_i ,
 - The **sum** of the additional areas of the N_i anchor nodules of radius a_i relative to a *flat* area according to the factor $\left(\frac{3}{2}\right)\left(\frac{N_i 4\pi a_i^2}{A_{Flat}}\right) / \left[1 + \frac{\delta}{a_i} + \frac{\delta^2}{2a_i^2}\right]$ where $\delta(\omega)$ is the skin depth at frequency ω not an arctangent function.



Dr. Yuriy Shlepnev

Simberian Software Corp



Impedance roughness correction coefficients

 Huray snowball model correction coefficient (HSCC, simplified)

$$K_{rhu} = 1 + \left(\frac{N \cdot 4\pi \cdot r^2}{A_{hex}}\right) / \left(1 + \frac{\delta}{r} + \frac{\delta^2}{2 \cdot r^2}\right)$$

 Modified Hammerstadt correction coefficient (MHCC)

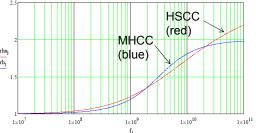
$$K_{rh} = 1 + \left(\frac{2}{\pi} \cdot \arctan\left[1.4\left(\frac{\Delta}{\delta}\right)^2\right]\right) \cdot (RF - 1) \frac{\kappa}{\kappa}$$

 Correction coefficients are applied to conductor surface impedance operator (causal correction)

$$Z_{cs}^{"} = K_{sr}^{1/2} \cdot Z_{cs} \cdot K_{sr}^{1/2}$$

Regular treated copper Huray model: r=0.85 um, At=65 um^2, N=11

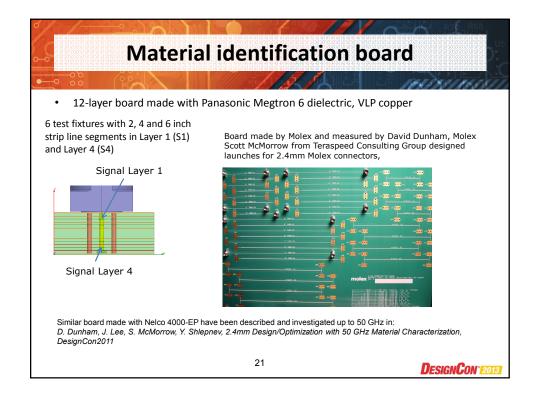
MHCC model: Delta= 1um, RF=2

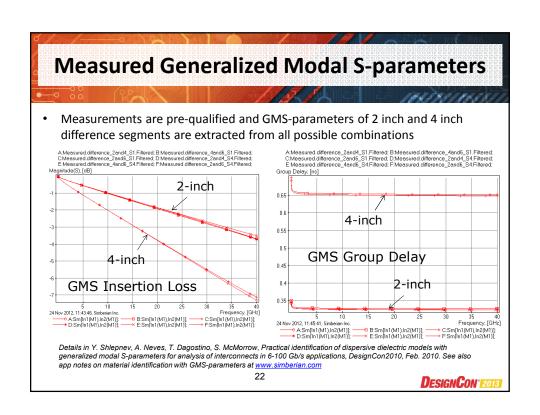


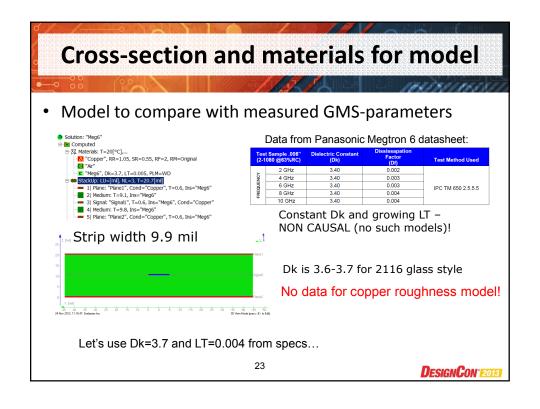
Do we need these models?
If yes, were to get model parameters?

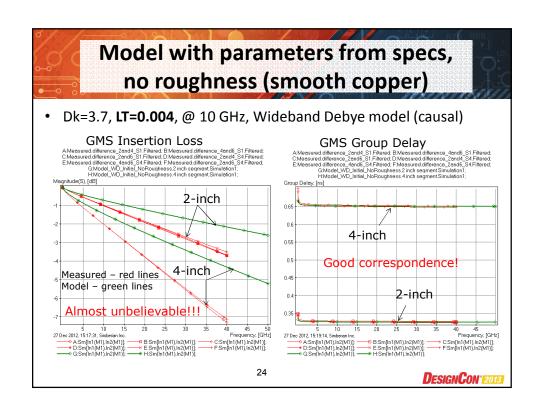
Details in Y. Shlepnev, C. Nwachukwu, Roughness characterization for interconnect analysis. - Proc. of the 2011 IEEE International Symposium on EMC, Long Beach, CA, USA, August, 2011, p. 518-523 See also our DesignCon 2012 paper – available at www.simberian.com

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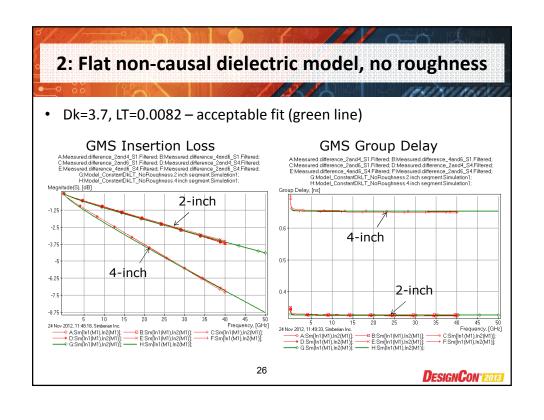




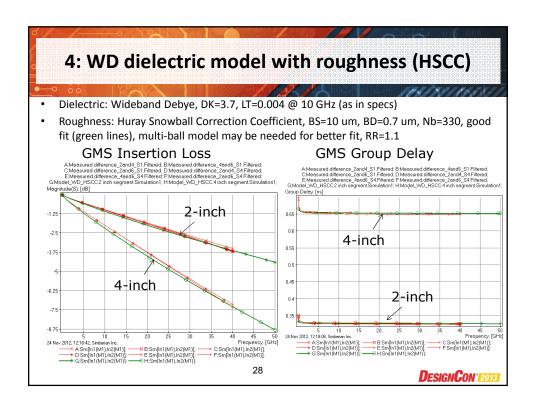


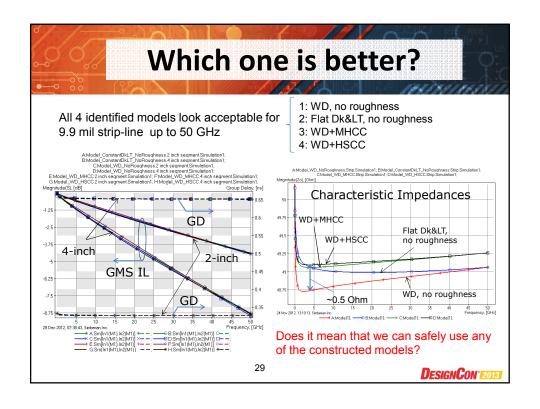


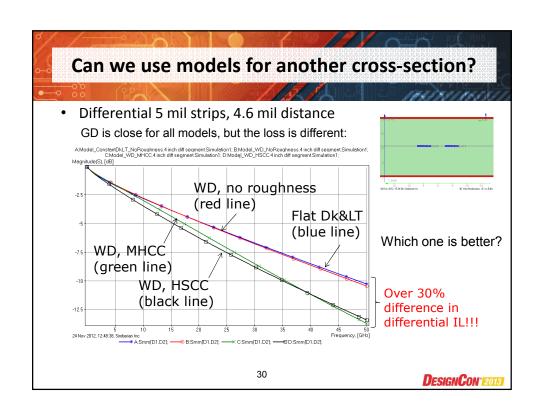
1: Adjusted dielectric model, no roughness • Wideband Debye model, DK=3.7, LT=0.0082 at 50 GHz, WD Low frequency is set to 10 GHz – good fit (green lines) GMS Insertion Loss A Measured difference, 2and 5.1 Filtered General difference, 4and 5.1 Filtered Consequence of GMS (A Filtered Consequence) (and 5.4 Filtered Consequence) (and 5.4



3: WD dielectric model with roughness (MHCC) • Dielectric: Wideband Debye, DK=3.7, LT=0.004 @ 10 GHz (as in specs) • Roughness: Modified Hammerstadt Correction Coefficient, SR=0.3 um, RF=5, RR=1.1 – excellent fit (green lines) GMS Insertion Loss Amesured difference, 2end 4, SI Fibred Comessued difference, 2end 4, SI Fib







Summary on practical identification

- Material models must be identified and verified on a set of crosssections for a particular board and manufacturer
 - Properly identified models will work on a set of cross-sections without additional adjustments
 - Improperly identified material models will require adjustments if crosssection changed (Whac-A-Mole game literally)
- Roughness model must be identified for low dielectric loss boards to use on a set of cross-sections
 - Without the appropriate roughness models, dielectric models may need adjustment for every cross section!

Similar investigations have been done for Nelco N4000-13EP and Isola FR-408 materials – see app notes at www.simberian.com or visit Simberian's booth #626

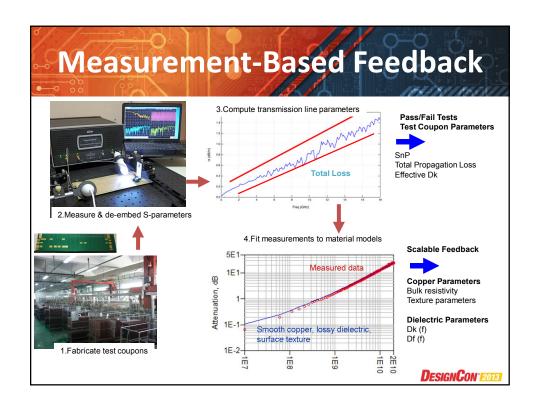
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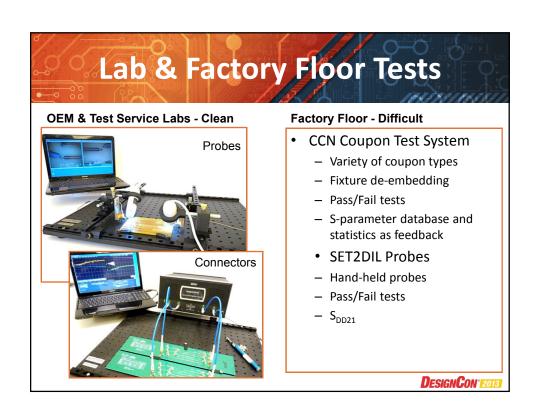
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Dr. Don DeGroot

CCN Labs and Andrews University





Parameters for Design Feedback

- 1 Acquire S-parameters from fabricator coupons
 - TDR or VNA Test Coupon Fixture System
- 2 Apply practical parameterization
 - Low frequency test to get copper bulk resistivity
 - Fit low frequency S using model of smooth copper and wideband Debye Dk & Df
 - Fit high freq. **S** by adjusting copper texture parameters
 - Feed the conductor and dielectric parameters back to CAD tools

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Coupons for Design Feedback

- Uniform transmission lines
 - NIST Multiline (CCN's Dk4 Test Coupon)
 - Differential and single-ended of two or more lengths
- IPC TM-650 2.5.5.12 Total Loss
 - SET2DIL
 - Short Pulse Propagation (like Multiline)
- Automatic Coupon Generator
 - Polar Instruments SpeedStack
 - Use correct fixture pads for de-embedding!

Summary

- Measurement-based material parameters can provide feedback from production to design
- Both copper texture approaches provide
 - A surface roughness scale
 - An increased surface area
 - Scalable feedback
- Approaches may not give unique parameters
 - Difficult to know precise geometry of conductors
 - Doesn't matter if used directly in the simulator

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Summary

 Ability to show accurate copper loss-to-dielectric loss fraction is key to manufacturing multigigabit channels.